

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4465036

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
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	VUONG BINH NGUYEN	05/25/2017
	DANA J. MEDLIN	06/06/2017
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Property Type	Number	
Application Number:	15625802	
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SIGNATURE:	/Hayley Read/	
DATE SIGNED:	06/16/2017	
Total Attachments: 2		
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ASSIGNMENT

Title of Invention: COMPOSITE JOINT ARTHROPLASTY SYSTEMS AND METHODS

Application Serial No.: 15/625,802

Filing Date: 06/16/2017

Maywood IP Law Docket No.: TFT-2

Whereas, the undersigned inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the Application;

Whereas, Titanium Fusion Technologies, LLC, a Limited Liability Company of Florida having a place of business at 8501 Amber Oak Drive Orlando, Florida 32817 ("Assignee"), desires to acquire, and each undersigned inventor desires to grant to Assignee, the entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;


Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor hereby sells or has sold, assigns or has assigned, and otherwise transfers or has transferred to Assignee, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the Application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. Each undersigned inventor agrees that, if the data above regarding the Application is incomplete, the missing data may be added hereto after receipt of the same from the United States Patent and Trademark Office.

In addition, each undersigned inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to Assignee, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by Assignee, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in Assignee, its successors, legal representatives, and assigns, whenever requested by Assignee, its successors, legal representatives, or assigns.

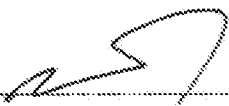
Each undersigned inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to Assignee and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned inventor also hereby grants Assignee, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of Utah, and any disputes will be resolved in a Utah state court or federal court sited in Utah.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

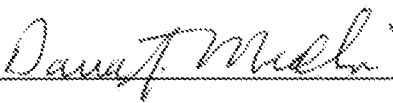
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